

MM74HC154 4-to-16 Line Decoder

General Description

The MM74HC154 decoder utilizes advanced silicon-gate CMOS technology, and is well suited to memory address decoding or data routing applications. It possesses high noise immunity, and low power consumption of CMOS with speeds similar to low power Schottky TTL circuits.

The MM74HC154 have 4 binary select inputs (A, B, C, and D). If the device is enabled these inputs determine which one of the 16 normally HIGH outputs will go LOW. Two active LOW enables ($\overline{G1}$ and $\overline{G2}$) are provided to ease cascading of decoders with little or no external logic.

Each output can drive 10 low power Schottky TTL equivalent loads, and is functionally and pin equivalent to the 74LS154. All inputs are protected from damage due to static discharge by diodes to V_{CC} and ground.

Features

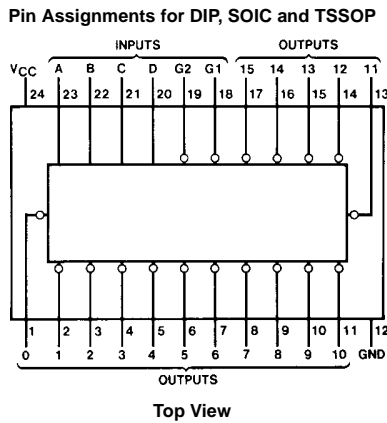
- Typical propagation delay: 21 ns
- Power supply quiescent current: 80 μ A
- Wide power supply voltage range: 2–6V
- Low input current: 1 μ A maximum

Ordering Code:

| Order Number | Package Number | Package Description |
|--------------|----------------|---|
| MM74HC154WM | M24B | 24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body |
| MM74HC154MTC | MTC24 | 24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| MM74HC154N | N24C | 24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300" Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

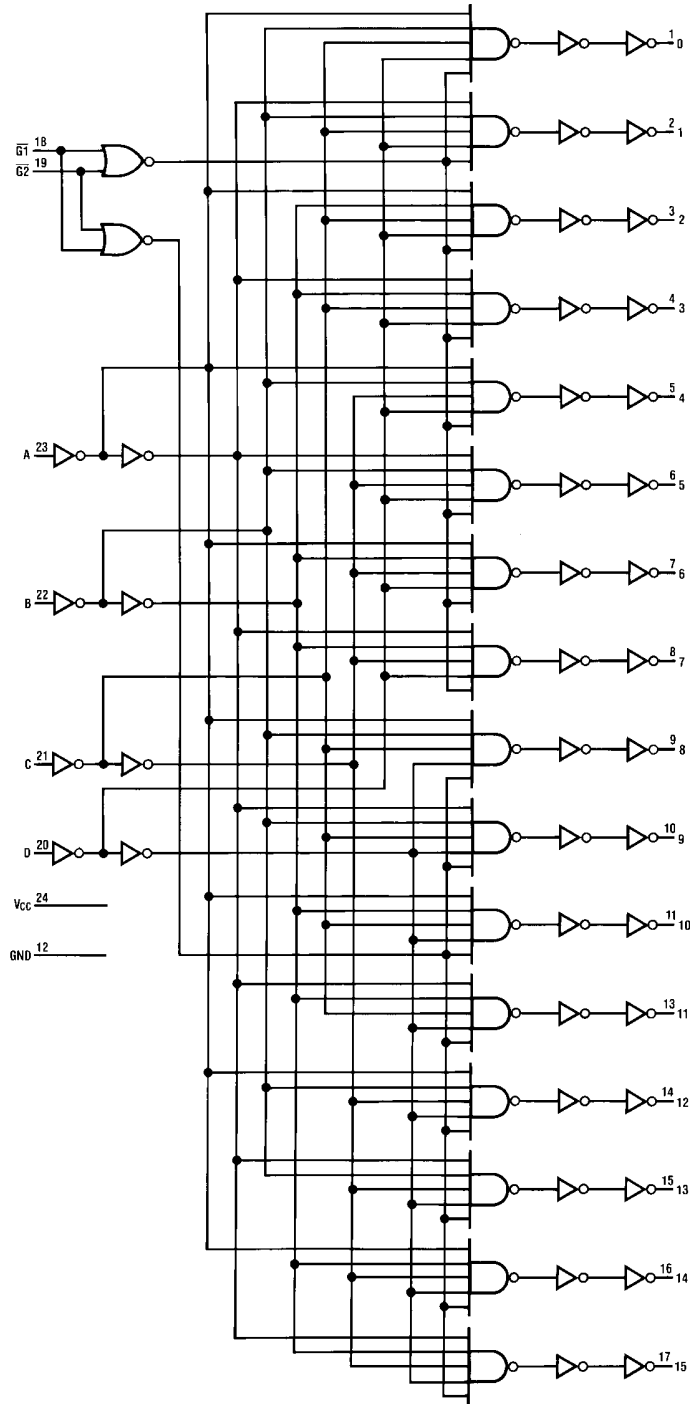


Truth Table

| Inputs | | Output (Note 1) |
|-----------------|-----------------|--------------------|
| $\overline{G1}$ | $\overline{G2}$ | |
| L | L | 0 |
| L | L | 1 |
| L | L | 2 |
| L | L | 3 |
| L | L | 4 |
| L | L | 5 |
| L | L | 6 |
| L | L | 7 |
| L | L | 8 |
| L | L | 9 |
| L | L | 10 |
| L | L | 11 |
| L | L | 12 |
| L | L | 13 |
| L | L | 14 |
| L | L | 15 |
| L | H | X |
| H | L | X |
| H | H | X |

Note 1: All others HIGH

Logic Diagram



| Absolute Maximum Ratings ^(Note 2) | | Recommended Operating Conditions | | | | | | |
|--|-----------------------------------|--|------------|--------------------|-------------------|------------------------------------|---------|-------|
| (Note 3) | | | | | | | | |
| Supply Voltage (V_{CC}) | -0.5 to +7.0V | Min | Max Units | | | | | |
| DC Input Voltage (V_{IN}) | -1.5 to $V_{CC} + 1.5V$ | 2 | 6 V | | | | | |
| DC Output Voltage (V_{OUT}) | -0.5 to $V_{CC} + 0.5V$ | 0 | V_{CC} V | | | | | |
| Clamp Diode Current (I_{IK}, I_{OK}) | ± 20 mA | Operating Temperature Range (T_A) | -40 +85 °C | | | | | |
| DC Output Current, per pin (I_{OUT}) | ± 25 mA | Input Rise or Fall Times | | | | | | |
| DC V_{CC} or GND Current, per pin (I_{CC}) | ± 50 mA | (t_r, t_f) $V_{CC} = 2.0V$ | 1000 ns | | | | | |
| Storage Temperature Range (T_{STG}) | -65°C to +150°C | $V_{CC} = 4.5V$ | 500 ns | | | | | |
| Power Dissipation (P_D) | | $V_{CC} = 6.0V$ | 400 ns | | | | | |
| (Note 4) | 600 mW | Note 2: Absolute Maximum Ratings are those values beyond which damage to the device may occur. | | | | | | |
| S.O. Package only | 500 mW | Note 3: Unless otherwise specified all voltages are referenced to ground. | | | | | | |
| Lead Temperature (T_L) | | Note 4: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C. | | | | | | |
| (Soldering 10 seconds) | 260°C | | | | | | | |
| DC Electrical Characteristics (Note 5) | | | | | | | | |
| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ C$ | | $T_A = -40 \text{ to } 85^\circ C$ | | Units |
| | | | | Typ | Guaranteed Limits | | | |
| V_{IH} | Minimum HIGH Level Input Voltage | | 2.0V | | 1.5 | 1.5 | V | |
| | | | 4.5V | | 3.15 | 3.15 | V | |
| | | | 6.0V | | 4.2 | 4.2 | V | |
| V_{IL} | Maximum LOW Level Input Voltage | | 2.0V | | 0.5 | 0.5 | V | |
| | | | 4.5V | | 1.35 | 1.35 | V | |
| | | | 6.0V | | 1.8 | 1.8 | V | |
| V_{OH} | Minimum HIGH Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \leq 20 \mu A$ | 2.0V | 2.0 | 1.9 | 1.9 | V | |
| | | | 4.5V | 4.5 | 4.4 | 4.4 | V | |
| | | | 6.0V | 6.0 | 5.9 | 5.9 | V | |
| | | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \leq 4.0 \text{ mA}$ $ I_{OUT} \leq 5.2 \text{ mA}$ | 4.5V | 4.2 | 3.98 | 3.84 | V | |
| | | | 6.0V | 5.7 | 5.48 | 5.34 | V | |
| | | | | | | | | |
| V_{OL} | Maximum LOW Level Output Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \leq 20 \mu A$ | 2.0V | 0 | 0.1 | 0.1 | V | |
| | | | 4.5V | 0 | 0.1 | 0.1 | V | |
| | | | 6.0V | 0 | 0.1 | 0.1 | V | |
| | | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \leq 4.0 \text{ mA}$ $ I_{OUT} \leq 5.2 \text{ mA}$ | 4.5V | 0.2 | 0.26 | 0.33 | V | |
| | | | 6.0V | 0.2 | 0.26 | 0.33 | V | |
| | | | | | | | | |
| I_{IN} | Maximum Input Current | $V_{IN} = V_{CC} \text{ or } GND$ | 6.0V | | ± 0.1 | ± 1.0 | μA | |
| I_{CC} | Maximum Quiescent Supply Current | $V_{IN} = V_{CC} \text{ or } GND$ $I_{OUT} = 0 \mu A$ | 6.0V | | 8.0 | 80 | μA | |
| Note 5: For a power supply of $5V \pm 10\%$ the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used. | | | | | | | | |

AC Electrical Characteristics $V_{CC} = 5V$, $T_A = 25^\circ C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

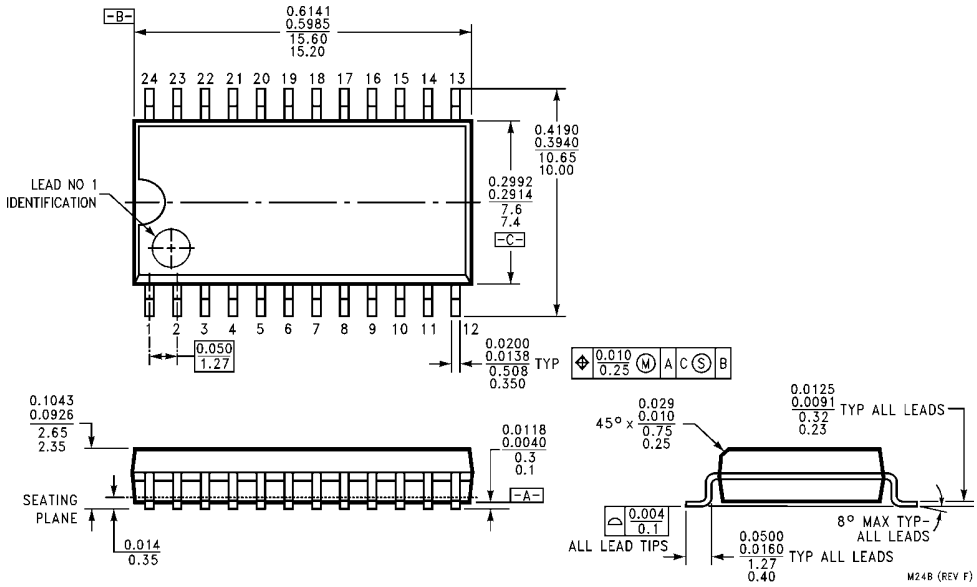
| Symbol | Parameter | Conditions | Typ | Guaranteed Limit | Units |
|-----------------------|--|------------|-----|------------------|-------|
| t_{PHL} , t_{PLH} | Maximum Propagation Delay, $\overline{G1}$, $\overline{G2}$ or A, B, C, D | | 21 | 32 | ns |

AC Electrical Characteristics $V_{CC} = 2.0V$ to $6.0V$, $C_L = 50$ pF, $t_r = t_f = 6$ ns (unless otherwise specified)

| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ C$ | | $T_A = -40$ to $85^\circ C$ | Units |
|-----------------------|---|------------|----------|--------------------|-------------------|-----------------------------|-------|
| | | | | Typ | Guaranteed Limits | | |
| t_{PHL} , t_{PLH} | Maximum Propagation Delay, $\overline{G1}$ or $\overline{G2}$ or A, B, C, D | | 2.0V | 63 | 160 | 190 | ns |
| | | | 4.5V | 24 | 36 | 42 | ns |
| | | | 6.0V | 20 | 30 | 35 | ns |
| t_{TLH} , t_{THL} | Maximum Output Rise and Fall Time | | 2.0V | 25 | 75 | 95 | ns |
| | | | 4.5V | 7 | 15 | 19 | ns |
| | | | 6.0V | 6 | 13 | 16 | ns |
| C_{PD} | Power Dissipation Capacitance (Note 6) | | | 90 | | | pF |
| C_{IN} | Maximum Input Capacitance | | | 5 | 10 | 10 | pF |

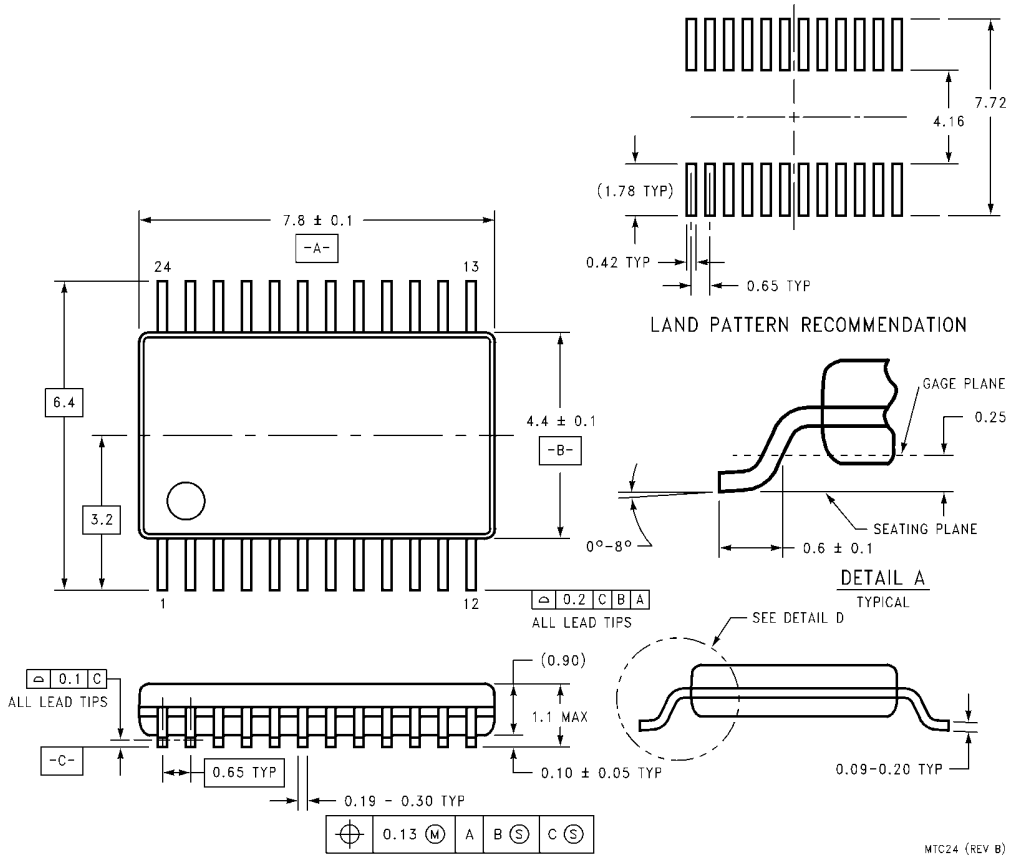
Note 6: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

Physical Dimensions inches (millimeters) unless otherwise noted



**24-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body
Package Number M24B**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

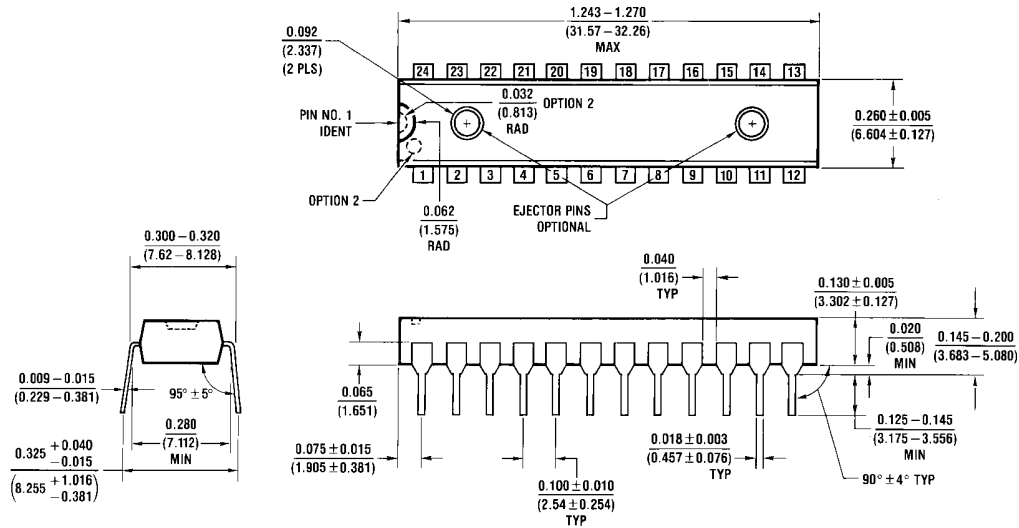


**24-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC24**

MTC24 (REV B)

Physical Dimensions

inches (millimeters) unless otherwise noted (Continued)



24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-100, 0.300" Wide Package Number N24C

N24C (REV F)

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